



MURS360

3.0A SURFACE MOUNT SUPER-FAST RECTIFIER

Product Summary (@TA = +25°C)

V _{RRM} (V)	lo (A)	V _F (V)	Ir (μA)	t _{RR} (ns)
600	3	1.25	3	50

Features and Benefits

- Glass Passivated Die Construction
- Super-Fast Recovery Time for High Efficiency
- Surge Overload Rating to 100A Peak
- Ideally Suited for Automated Assembly
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

Description and Applications

The super-fast recovery time of the MURS360 makes it suitable for boost diode in discontinuous or critical mode power factor corrections. The device is also intended for use as a free-wheeling diode in power supplies and other power switching applications.

Mechanical Data

- Case: SMC
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208⁽³⁾
- Polarity: Cathode Band or Cathode Notch
- Weight: 0.249 grams (Approximate)

SMC (Type C)



Top View



Bottom View

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
MURS360-13	Commercial	SMC (Type C)	3,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



U3J = Product Type Marking Code

| | = Manufacturer's Code Marking

YWW = Date Code Marking

Y = Last Digit of Year (ex: 1 for 2021)

WW = Week Code (01 to 52)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic			Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 6)		V _{RRM} V _{RWM} V _R	600	>
Average Rectified Output Current	@T _C = +140°C	lo	3.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load		IFSM	100	Α
Single Pulse Avalanche Energy	L = 15mH	Eas	10.8	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Air (Note 5)	R _θ JA	48	°C/W
Typical Thermal Resistance, Junction to Case (Note 5)	Rejc	10	°C/W
Typical Thermal Resistance, Junction to Lead (Note 5)	$R_{\theta JL}$	16	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +175	°C

Electrical Characteristics (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	600	_	_	V	$I_R = 3\mu A$
Forward Voltage	VF	_	_	1.25	V	IF = 3A, T _A = +25°C
Leakage Current (Note 6)	IR			3.0 150	μA	V _R = 600V, T _A = +25°C V _R = 600V, T _A = +150°C
Reverse Recovery Time	trr	_	_	50	ns	IF = 0.5A, IR = 1.0A, IRR = 0.25A
Total Capacitance	Ст	_	40	_	pF	V _R = 4V, f = 1.0MHz

Notes:

^{5.} Unit mounted on glass epoxy substrate 1oz/ft 10mm x 10mm copper pad.6. Short duration pulse test used to minimize self-heating effect.



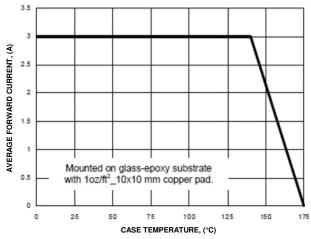


Figure 1. Forward Current Derating

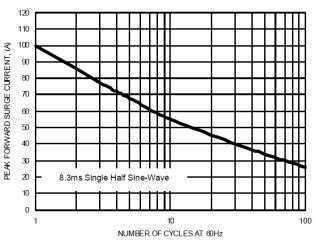


Figure 3. Maximum Non-Repetitive Surge Current

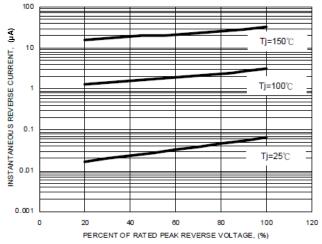


Figure 5. Typical Reverse Characteristics

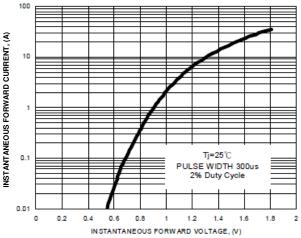


Figure 2. Typical Forward Characteristic

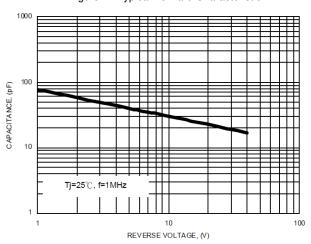


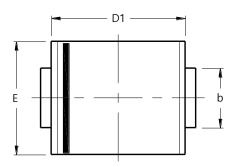
Figure 4. Typical Total Capacitance

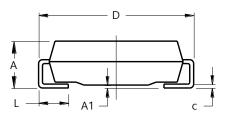


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SMC (Type C)



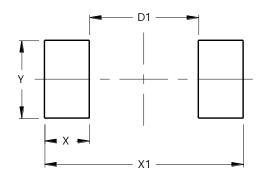


SMC (Type C)				
Dim	Min	Max	Тур	
Α	2.01	2.50		
A1	0.05	0.20		
b	2.92	3.18		
С	0.15	0.31		
D	7.75	8.13		
D1	6.60	7.11		
Е	5.59	6.22		
L	0.76	1.52		
All Dimensions in mm				

Suggested Pad Layout

 $Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$

SMC (Type C)



Dimensions	Value (in mm)		
G	5.60		
X	2.30		
X1	10.20		
Υ	4.00		



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